

Forward Looking Statements



Factors that could cause actual events or results to differ materially include, but not limited to, general business and economic conditions and the state of the semiconductor industry; market acceptance and competitiveness of the driver and non-driver products developed by the Company; demand for end-use applications products; reliance on a small group of principal customers; the uncertainty of continued success in technological innovations; our ability to develop and protect our intellectual property; pricing pressures including declines in average selling prices; changes in customer order patterns; changes in estimated full-year effective tax rate; shortages in supply of key components; changes in environmental laws and regulations; exchange rate fluctuations; regulatory approvals for further investments in our subsidiaries; our ability to collect accounts receivable and manage inventory and other risks described from time to time in the Company's SEC filings, including those risks identified in the section entitled "Risk Factors" in its Form 20-F for the year ended December 31, 2017 filed with the SEC, as may be amended. Images of devices depicted in this presentation may be representative of those in which Himax has specification, or for reference-only and may not be associated with actual bill-of-material or design-win in the displayed image. Any association of such, without a confirmed disclosure of such by the Company or the Company's customer are coincidental. Himax is under strict customer disclosure guidelines on the release of such information.

Recognized Industry Leade



For the last 30 years, we have worked with leading OEMs to develop and the most recognized imaging and human interfacing technologies.

1990s

Founder B.S. Wu pioneers flat panel technologies at Chimei Electronics as CTO



Board (TW) under "3222"

2000s

Chairman Wu establishes Himax to meet DDIC demand for large panels and fastgrowing medium and small panels







2010s

Himax gains market share with design wins with leading technology products companies, worldwide







2018 and Beyond

Himax leads WLO 3D sensing shipment and development with anchor North American OEM customer, QUALCOMM and Media Tek designpartnerships. LCOS advancements and WLO integration keep Himax at the forefront of AR/VR product design and pending product releases.



Google



LCOS and WLO, AMOLED DDIC, and

in-cell TDDI



2H2018

shipment

2018

2017

3D sensing:

SoC Players

Leading OEMs

Himax + Qualcomm

Industry first ASC 3D sensing reference design

with MediaTek and

smartphone OEMs.

WLO & 3D sensing

Megvii. TDDI ramp with

Corporate Timeline

August 2016 September 2015 Start expansion for AR business hits inflection March 2006 June 2001 October 2004 2009 June 2013 next generation point with pilot production Himax IPOs on Nasdag. Himax Taiwan formed Forms Himax Display to focus on GFC reduces sales ~\$900 million to ~\$700 Himax completes take out LCOS and WLO shipment made to a major Raises \$147M with Morgan production lines by B.S. Wu LCOS microdisplay technology million. Refocuses effort on non-driver products financing of Chimei Stanley US customer 2001 2002 2003 2004 2005 2006 2007 2008 2009 2010 2011 2012 2013 2014 2015 2016 2017 2010 - 2012 Non-driver sales increase gross margins and December 2003 August 2005 February 2007 **July 2013** 2016 BOM sales opportunities Himax Taiwan begins Himax Taiwan delists from Himax acquired Wisepal, and forms Signs investment Mass production and Himax Semiconductor to focus on small trading on Emerging Stock **Emerging Stock Board** agreement with shipment of AR related

and medium sized DDICs

Investment Highlights



Leading Imaging and Human Interfacing Technology Innovator

- Worldwide leading display driver player with a wide range of drivers for panels of all sizes and in-house intellectual property
- Image technology solutions provider

A Diversified Base of Customers and Revenues

- DDIC market share leader
- Top tier customers globally including partnerships with Qualcomm, MediaTek and investment from Google
- Diversified revenues from traditional DDIC to TDDI, 3D sensors, LCOS microdisplay, WLO
- WLO, 3D sensing and LCOS product lines to improve corporate profit margin
- Structured light and Active Stereo Camera (ASC) 3D sensing partnership with Qualcomm and MediaTek, respectively

Operational and Public Market Performances

- Long term profitability potential with no fundraising since IPO
- Disciplined cost control
- Stable cash flow
- Committed to high dividend payout ratio

Innovative New Products Capturing Growth Markets

- Integration of AMOLED and TDDI technologies fuel growth for core, display driver ICs
- Himax's WLO, CMOS & 3D image sensors, LCOS microdisplay's leading specs and continued design wins position us at the forefront of new AR/VR, IoT, Automotive LIDAR, HUD, Medical Devices, Robotics development and future product releases.

Visionary Management Team

Himax on NASDAQ

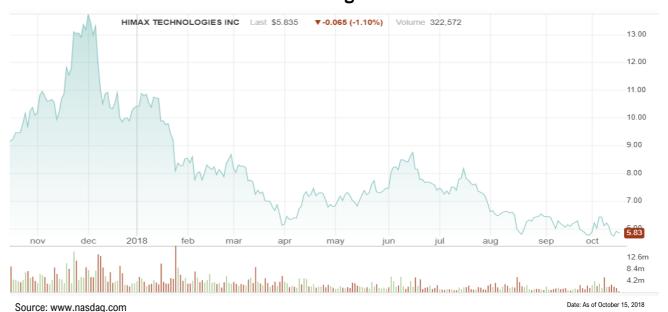


HIMX Nasdag Listed

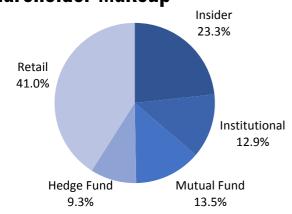
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Fiscal Year	December 3
Last-Traded Price (10/15/18)	\$5.90
Basic and Diluted Weighted Ave. Out. ADS	172.5
Equivalent ADS Out	172.1
Market Capitalization (10/15/18)	\$1.0 B
50-Day Avg. Daily Volume (10/15/18)	1,857,087
Annualized Dividend	\$0.09
Insider Ownership*	23.3%

^{*} Insider ownership includes executives and board members

12 Month Trading Chart



Shareholder Makeup



Date: As of Jun. 30, 2018

Analysts

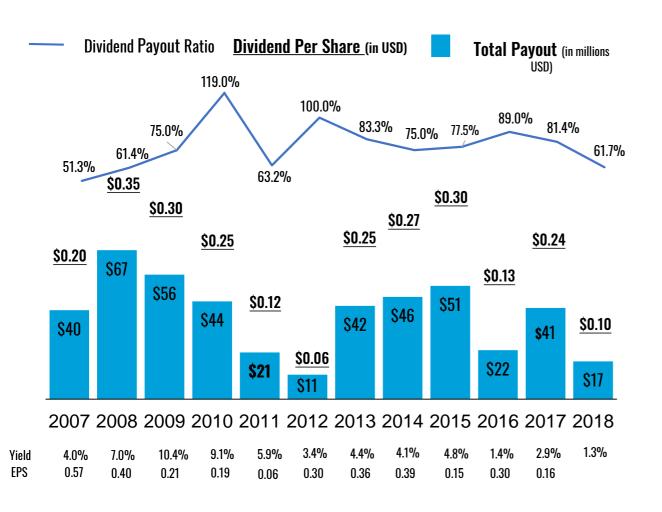
Cowen & Co.	Robert Stone
Credit Suisse	Jerry Su
Lake Street Capital Markets	Jaeson Schmidt
Macquarie Capital Securities Limited	Lynn Luo
Mizuho Securities Asia Ltd	Kevin Wang
Morgan Stanley	Charlie Chan
Nomura Securities	Donnie Teng
Northland Securities, Inc.	Gus Richard
Roth Capital Partners, LLC	Suji Desilva
RW Baird & Co.	Tristan Gerra

Shareholder-Focused, Returning Profits



Himax Dividend and Policy

- Distributed a total of \$458 million of dividend since IPO (Payout in July)
- Dividends referenced primarily on prior year's profitability
- Since its IPO, Himax Dividend Payout Ration to Net Income has not been less than 50% and as high as 119.0%. HIMX is part of Nasdaq's TDIV Dividend Index Fund

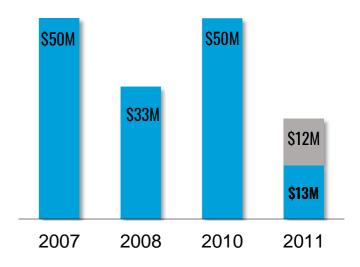


Himax Share Buyback

- Initiated four share buyback programs totaling \$158 million since 2007
- Repurchased a total of 46.5 million ADSs through June 30, 2018 at average purchase price per ADS: \$3.15

Executed Share Buybacks from 2007-2018(in millions USD)

Unutilized Portion



\$604

HAS BEEN RETURNED TO SHAREHOLDERS INCLUDING DIVIDENDS AND SHARE BUY BACKS SINCE IPO

Summary and Pre-Announced Financials



	202018***	202017***	102018***	YoY	QoQ
Revenues	\$181.4M	\$151.7M	\$162.9M	+19.5%	+11.4%
Gross Margin (%)	23.0%	23.8%	22.5%	-0.8%	+0.5%
IFRS Profit (loss)	\$2.0M	(\$0.7M)	(\$2.8M)	+400.9%	+172.3%
IFRS Earnings (loss) per ADS	\$0.012	(\$0.004)	(\$0.016)	+400.7%	+172.3%
Non-IFRS Profit (loss)	\$2.3M	(\$0.3M)	(\$2.6M)	+778.8%	+189.4%
Non-IFRS Earnings (loss) per ADS	\$0.013	(\$0.002)	(\$0.015)	+778.5%	+189.4%

FOR THE FULL YEAR 2017***

Revenues	\$685.2M
Gross Margin (%)	24.4%
IFRS Profit (loss)	\$27.7M*/ **
IFRS Earnings (loss) per ADS	\$0.161*/ **
Non-IFRS Profit (loss)	\$33.9M**
Non-IFRS Earnings (loss) per ADS	\$0.197**

October 5, 2018 - HIMAX PRE-ANOUNCED 3Q2018 FINACIAL RESULTS

***Revenues \$188.4 million, an increase of 3.9% sequentially vs. guidance of around flat from the last quarter.

***Gross Margin (%) 23.4% versus guidance of around 22.5%

/*IFRS Earnings (loss) per ADS 0.5 cents, higher than the Company's guidance of around -1.0 cents.

***Non-IFRS Earnings (loss) per ADS 2.6 cents, higher than the Company's guidance of around 1.5 cents.

^{* 2017} IFRS numbers include grant of Restricted Share Units at the end of September at \$6.1 million

^{** 2017} Q4 numbers include the disposal of an investment. Total proceeds from disposal are \$32.00 million with a pre-tax gain of \$23.04 million. Gain after tax is estimated to be \$20.74 million, representing a contribution of 12.0 cents earnings per diluted ADS

^{***} Beginning January 1, 2018, adopting International Financial Reporting Standards ("IFRS") to prepare consolidated financial statements; adjusting comparative period information in accordance with IFRS

^{**** 2018} Q3 IFRS numbers include grant of Restricted Share Units at the end of September at approximately \$4.5 million

A Gløbal Semiconductor Company



- Fabless semiconductor company with world leading visual imaging processing technologies
- Global market leader in TFT-LCD display driver and timing controller ICs
- 200+ customers across Taiwan,
 China, Japan, Korea, U.S. and Europe
- 2,983 patents granted and 493 patents pending approval worldwide as of September 30, 2018
- NASDAQ-listed since March 2006 (HIMX)
- Around 2,200 employees worldwide; more than 90% are engineers
- Headquartered in Tainan, Taiwan with 9 R&D centers in Taiwan, China, Korea, Israel and U.S., out of a total of 24 offices across Taiwan, China, Japan, Korea, Israel and U.S.

Himax's Global Reach



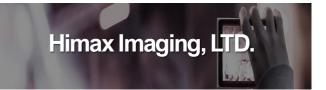
Corporate Structure



Himax Technologies, Inc.

Himax Technologies, LTD.

Himax Display, LTD.



- TFT-LCD Driver and AMOLED Driver
- TCON and P-Gamma OP
- Touch Controllers
- On-cell Touch
- Pure in-cell Touch (TDDI)
- ASIC Service and IP Licensing
- Power Management ICs
- Wafer Level Optics and 3D sensing modules
- Light guide
- In-house Color Filter Fab for LCOS and CIS

- LCOS Modules for Head-Mounted Display, Head-up Display and Pico-projector Applications
- Phase Modulation for Communication and Holographic Displays

CMOS Image sensors



























Display Driver IC (DDIC)





We are a leader in display driver ICs used to enable flat panel display in TFT, Touch and AMOLED in large, medium and small sized display panels

MARKETS WE SERVE

Smartphones, Tablets, Monitors, Notebooks, TVs, Automotive Gaming, Education, Healthcare plus 100's more applications for markets and business that use flat panel displays.

In what devices can you find Himax DDIC technologies



















Who uses Himax DDICs



Panasonic

























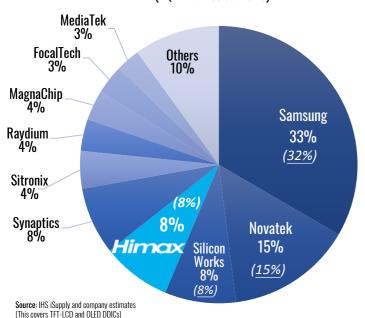


Our DDIC Market Share



2018 Q1 Driver Market Share

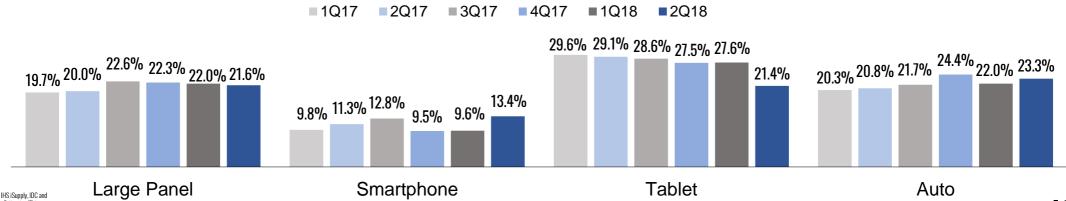




We have the ability to provide a complete solution of image processing technologies and leverage our expertise in mobile devices and other mass-market technology releases

- Large display driver IC business continue to benefit from Chinese panel customers' capacity expansion and China localization policy
- Increased smartphone market share driven by smartphone OEMSs transitioning to full-screen18:9 display for 2018 and 2019 models.
- Strong market share in fastest-moving consumer devices
- Leading market share position in auto applications
- Expect smartphone market share growth in 2H2018 and beyond due to TDDI

HIMX's Strong Driver IC Market Share in Mass Market Devices



Source: IHS iSupply, IDC and Company Estimates (This covers TFT-LCD DDICs)

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TDDI Technologies





We design technologies for touch sensor displays including in-cell touch and the fast-growing segment of Display Driver Integration (TDDI) single-chips

MARKETS WE SERVE

Beginning with smartphones, will expand to tablet, laptops, car navigation, and many other consumer electronic devices going forward

- Expect significant growth in 2H2018 and beyond
- Expect smartphone market share growth in 2H2018 and beyond due to TDDI
- New penetration of TDDI is refreshing smartphone life cycle starting end of 2016.
- Higher ASP & higher margin

In what devices can you find Himax display technologies



1.4" Smart watch, OLM GFM



5'~5.5" Smartphone, On-cell / GFF



8" Tablet PC, In-cell TDDI



5.65" FHD+ Smartphone, In-cell TDDI

Who uses Himax Touch and TDDI Technologies





















WLO and CMOS





We offer critical 3D sensing technologies, namely structured light, active stereo camera (ASC) and ToF, and optical finger print solution. Our CMOS image sensors include near infrared (NIR) sensors for 3D sensing and ultra-low power computer vision Always-on-Sensor (AoS™)

Wafer Level Optics (WLO)

Integrated Optics High Accuracy Scalability In Production Waveguide for AR

Key technology to enable holographic imaging for AR goggle devices

Best For IoT/Smart Sensing

Eye Tracking & Gesture Control 3D Depth Sensing

MARKETS WE SERVE

Smartphones, Consumer Electronics, Tablet, TV, Entertainment, Automotive, IoT, Gaming, Education, Healthcare plus many more...

Who uses Himax WLO and CMOS technologies































LCoS Microdisplays







We are the leader and long-term innovator of Liquid Crystal on Silicon (LCoS) displays and the only company capable of high-volume production runs of LCoS displays for the launch of mass-market devices.

Our Front Lit LCoS Technology Advantages

- Compact Form Factor
- Brightness
- Power Efficiency
- MP Efficiency & Readiness
- Contains lightquide performance enabling OEM to simplify light guide design
- Lower cost

MARKETS WE SERVE

Consumer, Shopping, Search, Gaming, Sports, AR/VR smart glasses, Automotive Heads Up Displays

Who uses Himax LCoS micro display technologies















Our Customers



DISPLAY DRIVERS

lenovo.



LG Display















WAFER LEVEL OPTICS

CMOS IMAGE SENSORS

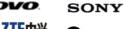




NUO















Coolpad











ASIC SERVICE & IP





LCOS MICRODISPLAYS







TOUCH PANEL

CONTROLLERS







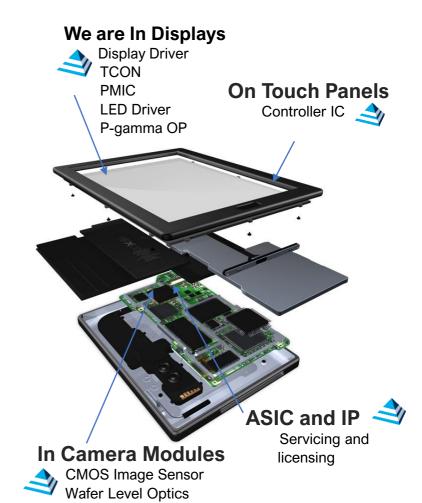


POWER MANAGEMENT IC & LED DRIVERS



TIMING CONTROLLERS











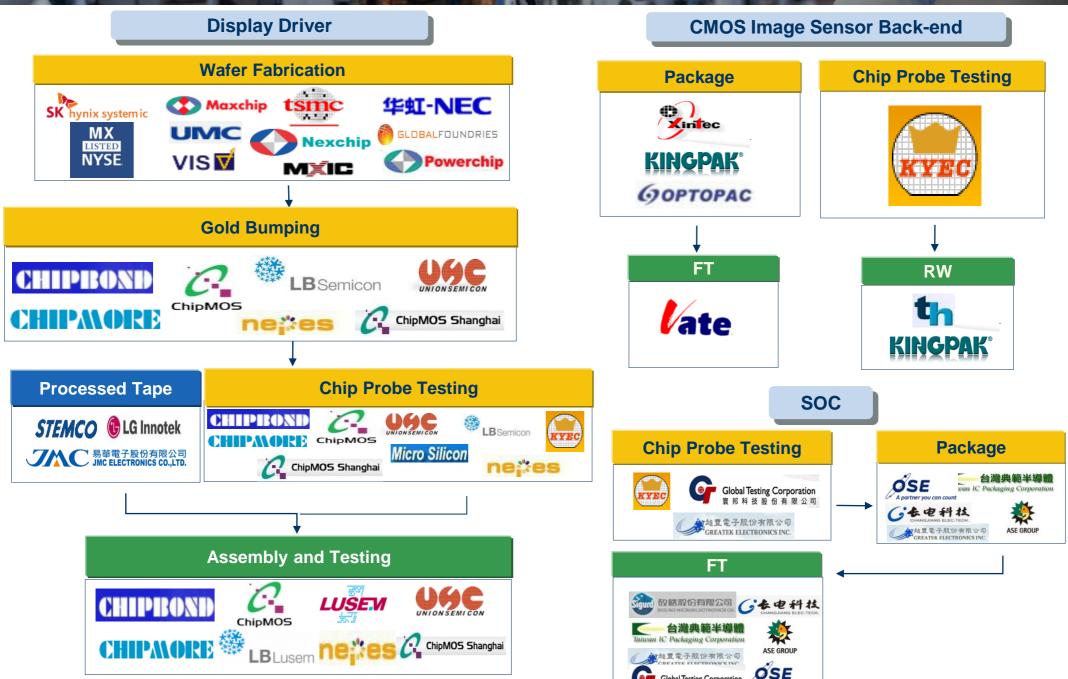


In VR Devices **OLED SOC**



Fabless Manufacturing Expertise





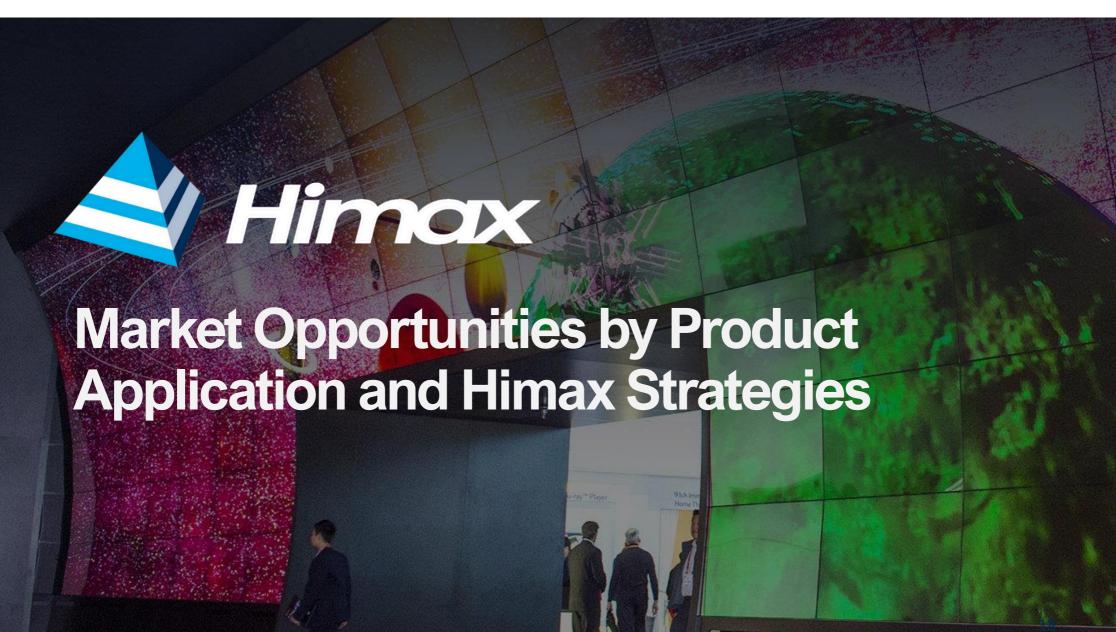












3D Sensing



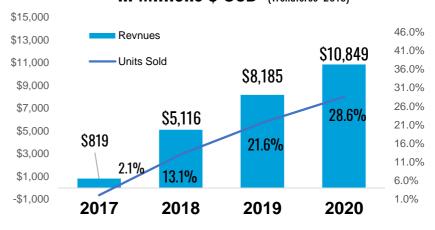
Market Trends

- Wafer-Level Optics (WLO)-enabled 3D sensing is a game-changing technology for next generation smartphones, tablets and new applications in AR/VR, industrial, IoT, AI, automotive, robotics, military, surveillance and drones
- CIS development is accelerating in functionality and new applications.
- New solutions are needed for Android smartphone edge-to-edge display: structured light, active stereoscopic camera (ASC) and timeof-flight (ToF) 3D sensing for facial recognition, as well as underdisplay optical sensor for fingerprint authentication

Himax Strategies and Market Position

- Qualcomm/Himax, SLiMTM, structured light based 3D sensing total solution is the highest quality 3D sensing total solution available for Android smartphones. Himax SLiMTM ASP is around \$20.
- ASC 3D sensing solution reference design, developed with MediaTek and Megvii, provides cost advantages and an existing dual camera ecosystem enabling us to work with top tier smartphone makers and leading platform partners on multiple projects to bring 3D features to the high volume Android market. Himax ASC ASP is around \$10.
- WLO: exceptional design know-how and proven MP track record deliver consistent product quality, production ramp and high yields to meet the demand for our anchor customer's current device and their future models.

3D Sensing Chip Sales and Adoption Rates in Millions S USD (Trendforce 2018)

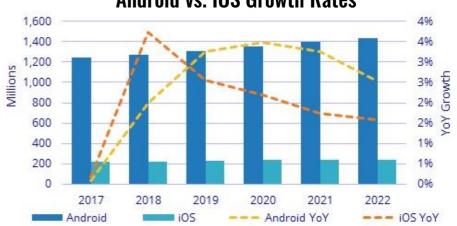


Himax's 3D Sensing Chip Development Partnerships



MEDI/ITEK

Android vs. IOS Growth Rates



Source: IDC 2018



Market Trends

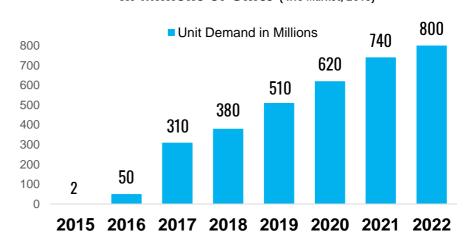
- Expect higher TDDI penetration in smartphones going forward and continue to accelerate
- Full screen 18:9 aspect ratio displays becoming the trend
- OEMs are meeting consumer demand for slimmer phones.
- New penetration of TDDI is refreshing smartphone life cycle, creating higher dollar content & margin opportunities

Himax Strategies and Market Position

TDDI pure in-cell solution

- Shipment started 4Q17, increasing revenue contribution starting 2018
- Numerous design-wins with top-tier names and most panel makers in China to enable super-slim bezels for customers' panel designs
- New generation FHD+ TDDI with COF package to enable super-slim bezel design for premium smartphone models
- The world's first TDDI design-wins for automotive application with mass production target of late 2019 to 2020
- Higher ASP and better margin than traditional driver IC
- Multiple design wins with major OEMs and new foundry capacity starting 2H2018 well positioned Himax to target 30% and above TDDI market share in 2019

TDDI Demand Forecast 2015-2022 In Millions of Units (IHS Market, 2018)



TDDI Technology Enables OEMs to Manufacture Thinner, Better and Less Expensive Phones



LCoS Microdisplays

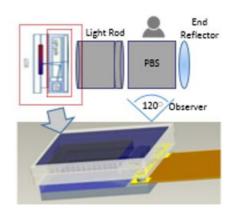


Market Trends

- Many top name multinationals or new start-ups are investing heavily to develop the AR ecosystem -- applications, software, operating system, system electronics, and optics
- Limited companies provide the combination of R&D, joint development and manufacturing expertise
- Significant barrier of entry to new market entrants and existing technology companies without scalable manufacturing

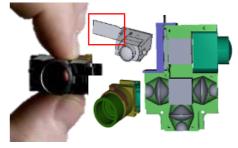
Himax Strategies and Market Position

- The leader in microdisplay with patent protected technology, inhouse facilities and shipping record >2M units
- Focus on AR goggle devices and HUD for automobiles
- List of AR goggle device customers covers many of the world's biggest tech names
- Close collaboration with tier 1 AR glasses device makers
- Strategic partners with top tier customers to provide phase modulation panel for communication and holographic display applications
- Design-wins of high-end HUD for automobiles major revenue contribution in 2019 at the earliest
- GM & OPM significantly higher than corporate average
- LCOS represents a significant long term growth opportunity for Himax



Front Lit LCOS Advantages

- Compact Form Factor
- Brightness
- Power Efficiency
- MP Efficiency & Readiness



Optical Engine with LCOS Module



Display Driver IC (DDIC)

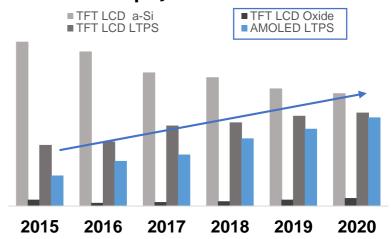
Market Trends

- Continuously aggressive new Gen 8 above TFT-LCD capacity expansion in China with a special focus on advanced display technologies
- Leading Chinese panel maker's shipment continue to rank world No. 1 in May 2018 and dominate in the No. 1 position of its total TFT-LCD capacity
- Chinese local TV set makers have started to in-source more and Chinese panel makers have started to export
- 4K TV penetration continues to accelerate and 8K TV is beginning to emerge
- · Demand of a total solution covering timing controllers, PMICs and driver ICs for advanced features in high end TVs
- Large panel DDIC market share remain strong due to increasing 4K TV penetration and CHN panel customers' ramping of new LCD fabs.

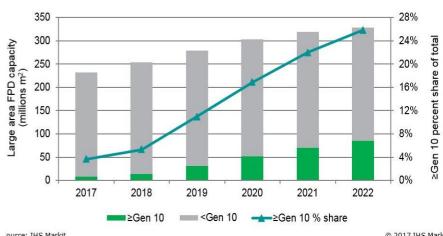
Himax Strategies and Market Position

- Major beneficiary of China capacity expansion and in-sourcing
- Leading market share in China
- Increased shipment of 4K solutions and working with major panel makers on the development of next gen 8K TVs
- Himax stands strong as OEMs seeking total solution providers for better performance, supply chain leverage, and more reliable engineering support

Continual Progression to Higher Resolution Displays and AMOLED



China Takes a Leading Role in Display Panel Manufacturing and DDIC Demand







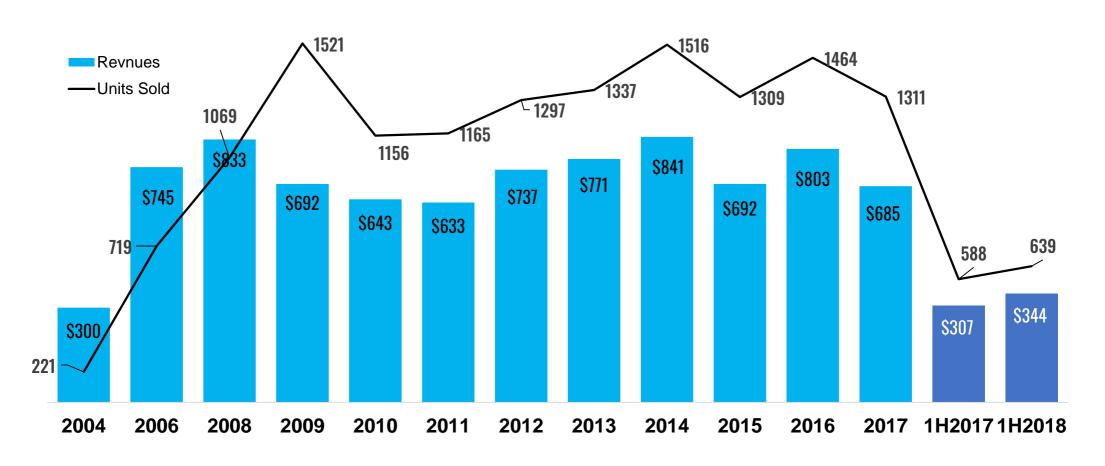
Unit and Revenue History



We are One of the Leading Semiconductor Companies in the World

We have shipped approximately 15 Billion Semiconductors

2002-1H2018 Unit Sales and Revenues (in millions of units and millions of \$USD)



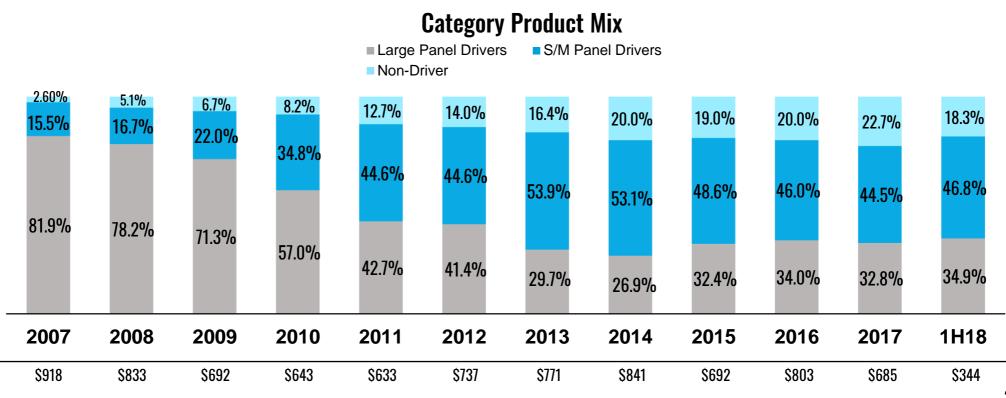
A Balanced Product Mix.



- Global market share leader in small and medium-sized panel driver ICs
- Market leader in 3D sensing Structured light and active stereoscopic 3D sensing total solutions will represent a paradigm shift when it starts to achieve a broader market adoption
- Increasing non-driver sales diversifies customer base, improves product mix and lifts gross margin
- Innovative technologies in Advanced Wafer Level Optics, CIS and LCOS microdisplays
 - GM & OPM significantly higher than corporate average
 - Phenomenal ROI

Revenues

- AR technology provider of choice
- Total solution component provider



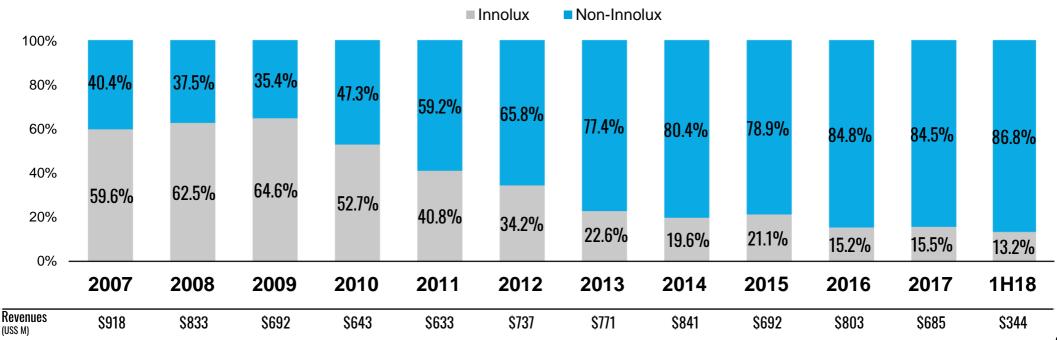
...and a Diversified Customer Base



Largely reduced dependence on one single customer, Innolux.

- Diversifying product revenues by non-driver product wins and leveraging existing customers
- Innolux disposed of its entire equity holding in Himax on June 19th, 2013, ending its status as Himax's related party
- Growing shipment to new panel manufacturer customers in China, Korea and Taiwan since 2013
- Market share leadership in core driver IC business
- Benefiting from China localization, capacity expansion
- Expanding customer base to include many global top tier tech companies for LCOS microdisplay, Wafer Level Optics, 3D sensing and CMOS image sensors

2007-1H2018 Customer Diversification

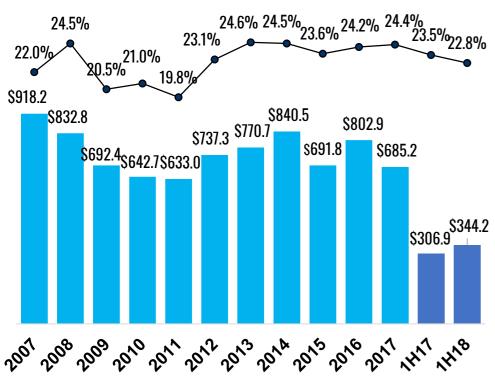


Gross Margin is a Key Business Focus



Revenues & Gross Margin %

US\$M in Revenues and Gross Margin % of Sale



Better product mix lifts blended margin

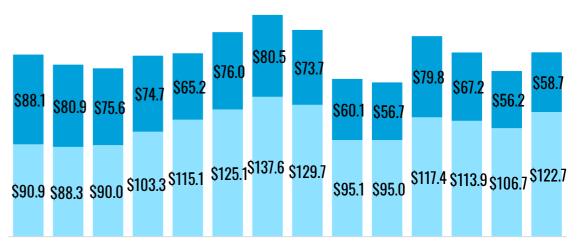
- Successful transformation since 2011
- Revenues growth and improved gross margin in 2016 due to product mix
- Positive about long term growth

Geographical Revenue Mix & Quarterly GM

US\$M in Revenues and Quarterly Gross Margins

■ China Sales ■ ROW Sales

Quarterly Gross Margin Percentages 2016 3016 2017 3017 4017 2018 3015 4015 26.1% 25.6% 19.1% 23.1% 23.8% 25.5% 22.5% 23.0% 22.9% 26.2% 24.6%

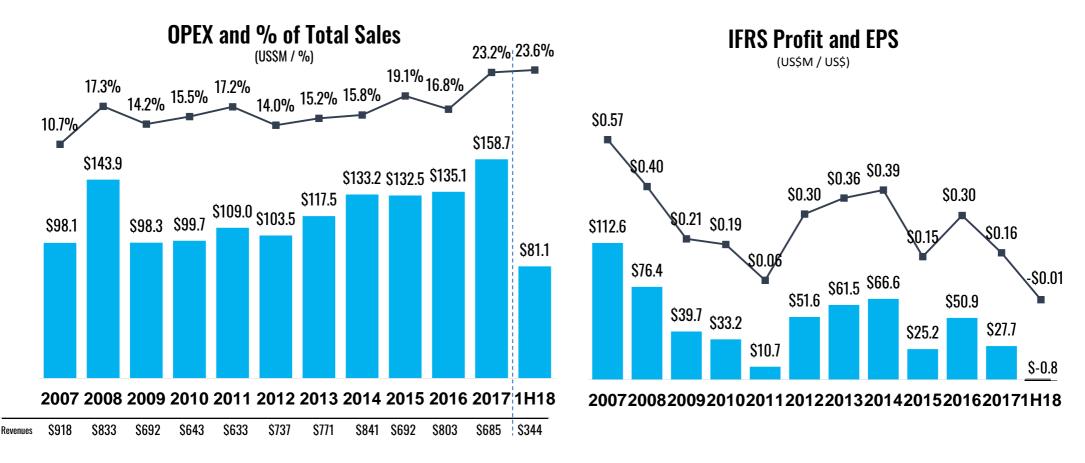


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- GM retraction in 2015: higher mix of China sales and competitive pricing in the LDDIC market
- GM improvement in 2016
 - Resolution migration improved GM of SMDDIC
 - Favorable product mix with higher non-driver sales %: LCOS and WLO sales growth
 - Lower GM in 4Q16 due to an additional inventory write-down
- Improved GM in 2H vs. 1H in 2017 driven by more favorable product mix which due primarily to WLO shipments starting in July, 2017, and the oneoff customer reimbursements related to AR goggle device business in Q3
- Further GM improvement will come from non-driver business growth

OPEX and the Bottom Line

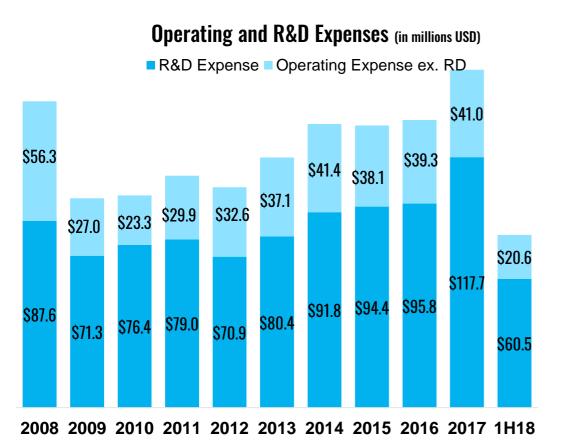


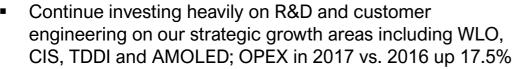


- Continue to streamline core business R&D efforts and execute expense control through product integration
- Unprecedented Phase I capital expansion in 2017: construction of a new building, increase of WLO capacity for the anchor customer and MP ready for SLiM and ASC 3D sensing solutions
- Completion of the new building in 2017: house additional WLO capacity, the new active alignment equipment, and extra
 office spaces
- Increase Phase I capex to meet the substantially rising demand of 3D sensing Android market starting 2019
- Continue committing on R&D and customer engineering on our strategic growth area that will bring in handsome return in the next few years
- Short-term profit setback due to higher R&D in non-driver technology development
- The capex budget for 2018 will be funded through internal resources and banking facilities, if so needed

Performance History







\$133.2 \$132.5 \$135.1

\$158.7

\$81.1

2014, 2015 & 2016 & 2017 OPEX include RSU \$9.3mn,
 \$4.5mn, \$9.2mn and \$6.1mn

\$117.5

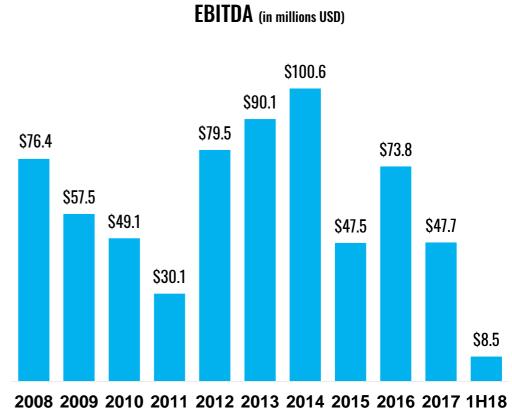
\$108.9 \$103.5

Total Operating and R&D Expense

\$98.3

\$99.7

\$143.9



- Robust profit growth in 2016 as a result of revenue growth and GM enhancement from new product
- Short-term profit setbacks caused by additional R&D expense and WLO capacity expansion
- Positive long term profitability outlook

June 30, 2018 Income Statement



For the Fiscal Period Ended	<u>2Q-2018</u> (Unaudited)	<u>2Q-2017</u> (Unaudited)	<u>1Q-2018</u> (Unaudited)	<u>Y2017</u> (Unaudited)
Revenues	\$181,365	\$151,730	\$162,851	\$685,167
Cost of revenues	139,571	115,556	126,254	518,142
Gross profit Gross margin	41,794 23.0%	36,174 23.8%	36,597 22.5%	167,025 <i>24.4%</i>
Operating expenses Research and development General and administrative Sales and marketing Total operating expenses	30,444 5,632 5,218 41,294	27,923 4,521 4,647 37,091	30,040 4,906 4,895 39,841	117,662 20,461 20,543 158,666
Operating income (loss)	500	(917)	(3,244)	8,359
Non-operating income (loss)	1,202	(295)	(800)	21,733
Profit (loss) before income taxes	1,702	(1,212)	(4,044)	30,092
Income tax expense (benefit) Profit (loss) for the period Add: Loss attributable to noncontrolling interests	306 1,396 650	(179) (1,033) 353	(728) (3,316) 487	4,554 25,538 2,142
Profit (loss) attributable to Himax stockholders	\$2,046	(\$680)	(\$2,829)	\$27,680
Non-IFRS Profit (loss) attributable to Himax stockholders	\$2,301	(\$339)	(\$2,575)	\$33,889
IFRS earnings (loss) per ADS attributable to Himax stockholders (in cents Basic Diluted	1.2 1.2	(0.4) (0.4)	(1.6) (1.6)	16.1 16.1
Non-IFRS earnings (loss) per ADS attributable to Himax stockholders (in d Basic Diluted	cents) 1.3 1.3	(0.2) (0.2)	(1.5) (1.5)	19.7 19.7

June 30, 2018 Balance Sheet



	June 30, 2018 (Unaudited)	March 31, 2018 (Unaudited)	June 30, 2017 (Unaudited)
<u>Assets</u>			
Current Assets:			
Cash and cash equivalents	\$114,480	\$139,806	\$177,206
Financial assets at amortized cost	12,154	11,753	5,306
Financial assets at fair value through profit or loss	66	361	3,357
Accounts receivable, net	176,286	166,603	164,516
Inventories	142,077	147,962	147,680
Restricted deposit	147,000	147,000	107,201
Other current assets	21,591	23,169	16,479
Total current assets	613,654	636,654	621,745
Financial assets at fair value through profit or loss	1,574	1,600	10,562
Financial assets at fair value through other comprehensive income	802	1,522	1,680
Equity method investment	9,964	9,905	4,055
Property, plant and equipment, net	106,041	95,953	53,852
Goodwill	28,138	28,138	28,138
Other Assets	25,479	20,286	16,366
<u>Total Assets</u>	\$785,652	\$794,058	\$736,398
Liabilities and Equity			
Current liabilities:	Φ4.4 7 .000	#447.000	#407.000
Short-term borrowings*	\$147,000	\$147,000	\$107,000
Accounts payable	128,862	134,970	113,670
Other current liabilities	67,188	56,441	80,639
Total current liabilities	343,050	338,411	301,309
Other liabilities	6,808	4,956	8,595
Himax stockholders' equity	438,689	452,917	426,943
Noncontrolling interest	(2,895)	(2,226)	(449)
Total Liabilities and Equity	\$785,652	\$794,058	\$736,398

 $[\]hbox{* Short-term borrowings is guaranteed by restricted deposit}$

June 30, 2018 Cash Flow Statement



	2Q-2018 (Unaudited)	1Q-2018 (Unaudited)	2017FY (Unaudited)
Profit (loss) for the period	<u>\$1,396</u>	<u>(\$3,316)</u>	<u>\$25,538</u>
Depreciation and amortization	5,180	5,098	16,680
Bad debt expenses	190	0	155
Share-based compensation expenses	93	91	997
Gain on disposals of property, plant and equipment	0	О	(26)
Gain on re-measurement of the pre-existing relationships in a business combination	(1,662)	О	О
Changes in fair value of financial assets at fair value through profit or loss	25	(1)	(23,226)
Interest income	(672)	(549)	(2,225)
Finance costs	265	252	878
Income tax expense (benefit)	306	(728)	4,554
Share of losses of associates	1,099	844	1,200
Inventories write downs	3,567	2,954	12,298
Foreign currency exchange losses (gains) of financial assets	340	(222)	0
Changes in:	10,127	4,423	36,823
Decrease (increase) in accounts receivable	(9,872)	22,171	(1,665)
Decrease (increase) in inventories	2,318	(15,716)	2,250
Decrease in accounts payable	(6,108)	(4,963)	(2,336)
Others	2,929	(3,597)	7,404
Cash generated from operating activities	(606)	2,318	42,476
Interest received	1,014	166	2,165
Interest paid	(182)	(170)	(565)
Income tax paid	(3,032)	(37)	(14,683)
Net cash provided by (used in) operating activities	(\$2,806)	\$2,277	\$29,393
Purchases of property, plant and equipment	(17,745)	(18,550)	(39,292)
Acquisitions of financial assets at amortized cost	(1,135)	(1,897)	(5,572)
Proceeds from disposal of financial assets at amortized cost	303	754	744
Acquisitions of financial assets at fair value through profit or loss	(7,445)	(4,330)	(41,523)
Proceeds from disposals of financial assets at fair value through profit or loss	7,693	26,506	56,375
Others	(3,913)	(3,243)	(5,820)
Net cash used in investing activities	(\$22,242)	(\$760)	(\$35,088)
Payments of cash dividends	0	0	(41,281)
Pledge of restricted deposit	О	0	(9,000)
Proceeds from short-term borrowings	27,000	О	151,161
Repayments of short-term borrowings	(27,000)	О	(142,161)
Others	О	11	67
Net cash provided by (used in) financing activities	\$0	\$11	(\$41,214)
Effect of foreign currency exchange rate changes	(278)	255	480
Net increase (decrease) in cash and cash equivalents	<u>(\$25,326)</u>	<u>\$1,783</u>	<u>(\$46,429)</u>
Cash and cash equivalents at beginning of period	<u>\$139,806</u>	<u>\$138,023</u>	<u>\$184,452</u>
Cash and cash equivalents at end of period	<u>\$114,480</u>	<u>\$139,806</u>	<u>\$138,023</u>

Management Team





Dr. Biing-Seng Wu, Chairman of the Board - Dr. Wu, the founder of Himax, previously served as President, CEO and a Director of Himax Taiwan. As a pioneer of TFT-LCD panel industry in Taiwan, Dr. Wu has been active in the TFT-LCD panel industry for over 20 years. With 61 patents related to Flat Panel Display granted worldwide, Dr. Wu has made significant contributions to Taiwan panel industry including the completion and operation of Taiwan's very first TFT-LCD plant, the winner of Outstanding Industry Contribution Award at the Gold Panel Awards 2009 from Ministry of Economic Affairs, etc. Dr. Wu holds a B.S. degree, an M.S. Degree and a Ph.D. Degree in Electrical Engineering from National Cheng Kung University. With well-recognized outstanding research and development capabilities, Dr. Wu received numerous awards including National Invention Award of Taiwan from Taiwan Executive Yuan in 1992, Research Achievement Awards from Industrial Technology Research Institute for two consecutive years in 1992 and 1993, ERSO Award from Pan Wen Yuan Foundation in 2008, etc.



Jordan Wu, President, CEO and Director- Mr. Wu, co-founder of Himax, previously served as the Chairman of the Board of Himax Taiwan since April 2003. Prior to joining Himax Taiwan, he served as CEO of TV Plus Technologies, Inc. and CFO and Executive Director of DVN Holdings Ltd. in Hong Kong. Mr. Wu holds a B.S. degree in Mechanical Engineering from National Taiwan University and an M.B.A. degree from the University of Rochester.



Jackie Chang, Chief Financial Officer - Before joining Himax, Ms. Chang was the CFO of Castlink Corporation and VP of Finance and Operations for PlayHut, Inc. Prior to that, Ms. Chang was General Manager -Treasury Control for Nissan North America. She held several positions in Nissan North America during 1994 -2006 including finance, treasury planning, operations and accounting. She holds a BBA in Accounting from the National Chung-Hsing University in Taiwan and an MBA in Finance from Memphis State University.



Jackie Chang, CFO

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